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NXP Semiconductors/Freescale Semiconductor, Inc. BT148-500R,127

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Datasheet of BT148-500R,127 - THYRISTOR 500V 4A SOT82

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Product data sheet

1. General description

Planar passivated SCR with sensitive gate in a SIP3 (SOT82) plastic package intended for use in general purpose switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

2. Features and benefits

- Sensitive gate
- · Planar passivated for voltage ruggedness and reliability
- · Direct triggering from low power drivers and logic ICs

3. Applications

- Adapters
- Battery powered applications
- Industrial automation

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DRM}	repetitive peak off- state voltage		[1]	-	-	500	V
V_{RRM}	repetitive peak reverse voltage			-	-	500	V
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$; $Fig. 4$; $Fig. 5$		-	-	35	Α
I _{T(RMS)}	RMS on-state current	half sine wave; $T_{mb} \le 113 ^{\circ}\text{C}$; Fig. 2; Fig. 3		-	-	4	A
Static characteristics							
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 ^{\circ}\text{C}; Fig. 7$		-	15	200	μA

^[1] Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/µs.





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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	[,]	A -
2	Α	anode		G sym037
3	G	gate		,
mb	A	mounting base; connected to anode		
			SIP3 (SOT82)	

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BT148-500R	SIP3	plastic single-ended package; 3 leads (in-line)	SOT82		

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		[1]	-	500	V
V_{RRM}	repetitive peak reverse voltage			-	500	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 113 °C; <u>Fig. 1</u>		-	2.5	Α
I _{T(RMS)}	RMS on-state current	half sine wave; $T_{mb} \le 113 \text{ °C}$; Fig. 2; Fig. 3		-	4	А
I _{TSM}	non-repetitive peak on-state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$; Fig. 4; Fig. 5		-	35	А
		half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 8.3 \text{ ms}$		-	38	Α
l ² t	I ² t for fusing	t _p = 10 ms; SIN		-	6.1	A ² s
dl _T /dt	rate of rise of on-state current	$I_T = 10 \text{ A}$; $I_G = 50 \text{ mA}$; $dI_G/dt = 50 \text{ mA}/$ µs		-	50	A/µs
I _{GM}	peak gate current			-	2	Α
V_{RGM}	peak reverse gate voltage			-	5	V
P_{GM}	peak gate power			-	5	W
P _{G(AV)}	average gate power	over any 20 ms period		-	0.5	W
T _{stg}	storage temperature			-40	150	°C
Tj	junction temperature		[2]	-	125	°C

^[1] Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/µs.

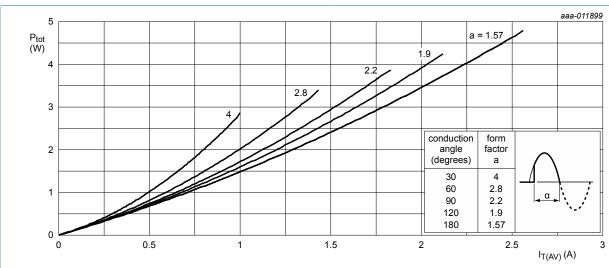
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^[2] Operation above 110°C may require the use of a gate to cathode resistor of $1k\Omega$ or less.

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 α = conduction angle

 $a = form factor = I_{T(RMS)} / I_{T(AV)}$

Fig. 1. Total power dissipation as a function of average on-state current; maximum values

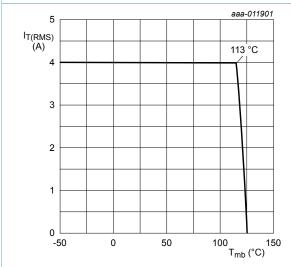
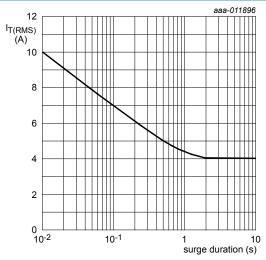


Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values



 $f = 50 \text{ Hz}; T_{mb} = 113 \,^{\circ}\text{C}$

Fig. 3. RMS on-state current as a function of surge duration; maximum values

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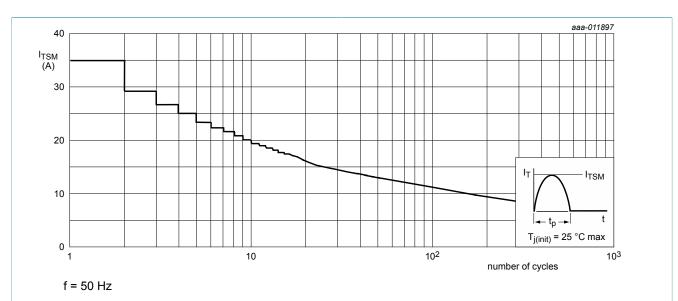
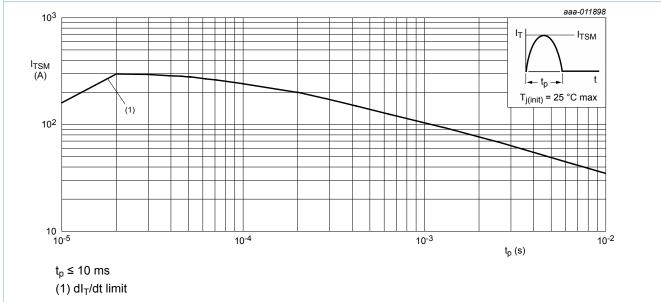


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum



Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

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8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 6	-	-	2.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	95	-	K/W

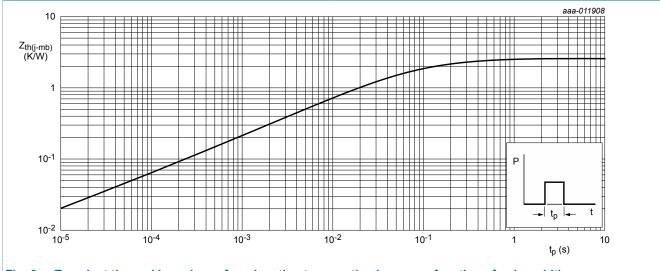


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width

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9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 ^{\circ}\text{C}; Fig. 7$	-	15	200	μA
IL	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25 ^{\circ}\text{C}; Fig. 8$	-	0.17	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	0.1	6	mA
V_{T}	on-state voltage	I _T = 5 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.23	1.8	V
V_{GT}	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$ Fig. 11	-	0.4	1	V
		$V_D = 500 \text{ V}; I_T = 0.1 \text{ A}; T_j = 110 ^{\circ}\text{C};$ Fig. 11	0.1	0.2	-	V
I _D	off-state current	V _D = 500 V; T _j = 125 °C	-	0.1	0.5	mA
I _R	reverse current	V _R = 500 V; T _j = 125 °C	-	0.1	0.5	mA
Dynamic c	haracteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 268 V; T_j = 125 °C; R_{GK} = 100 Ω; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12	-	50	-	V/µs
t _{gt}	gate-controlled turn-on time	I_{TM} = 10 A; V_D = 500 V; I_G = 5 mA; $dI_G/$ dt = 0.2 A/µs; T_j = 25 °C	-	2	-	μs
tq	commutated turn-off time	V_{DM} = 268 V; T_j = 125 °C; I_{TM} = 8 A; V_R = 10 V; $(dI_T/dt)_M$ = 10 A/ μ s; dV_D/dt = 2 V/ μ s; R_{GK} = 1 k Ω ; $(V_{DM}$ = 67% of $V_{DRM})$	-	100	-	μs

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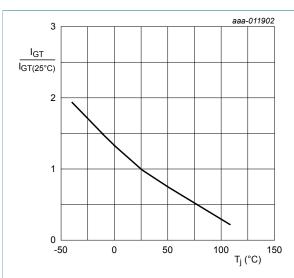
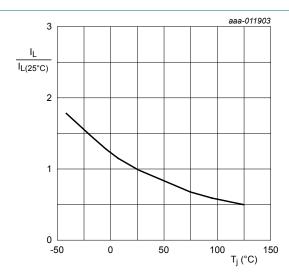


Fig. 7. Normalized gate trigger current as a function of junction temperature



 $R_{GK} = 1 k\Omega$

Fig. 8. Normalized latching current as a function of junction temperature

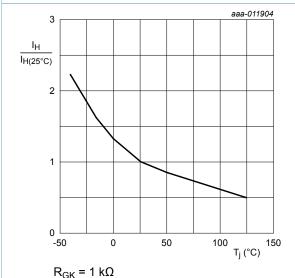
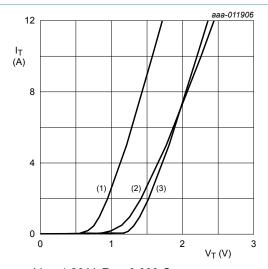


Fig. 9. Normalized holding current as a function of junction temperature



 V_o = 1.26 V; R_s = 0.099 Ω

Fig. 10. On-state current as a function of on-state voltage

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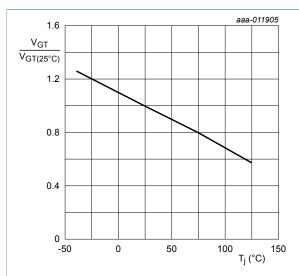


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

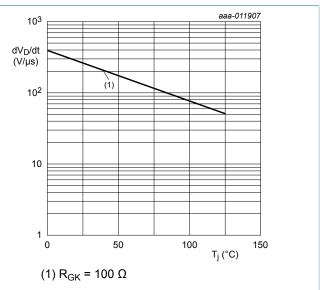


Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values



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10. Package outline

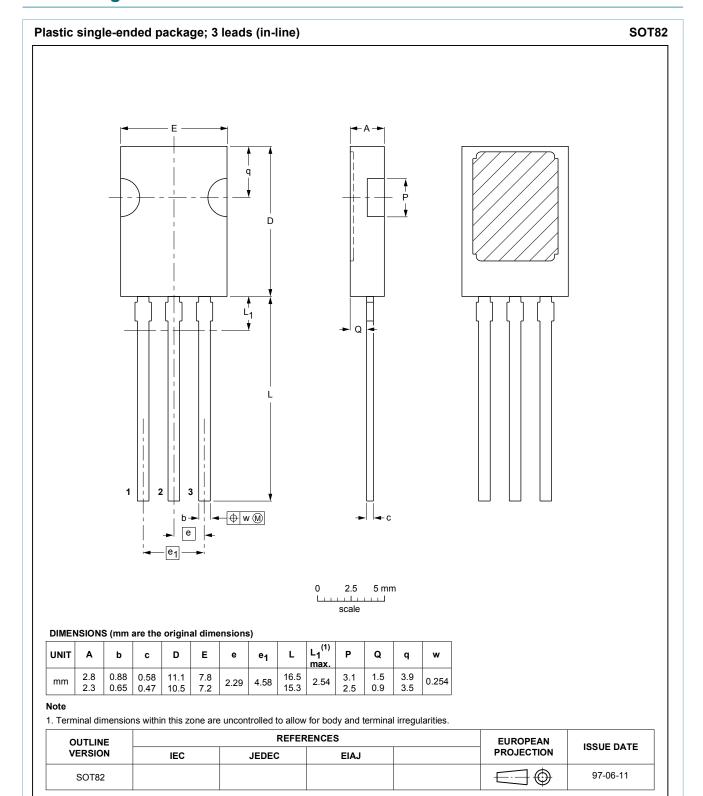


Fig. 13. Package outline SIP3 (SOT82)

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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